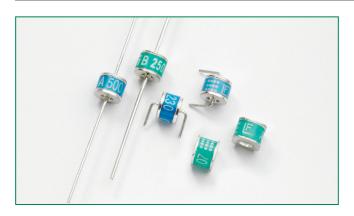
Gas Discharge Tube (GDT) Products SL1011A/B and SL1411A Series

RoHS

SL1011A/B and SL1411A Series





Agency Approvals

AGENCY	AGENCY FILE NUMBER
<i>I</i> R ®	E128662

2 Electrode GDT Graphical Symbol



Description

The SL1011A/B and SL1411A series provides high levels of protection against fast rising transients in the 100V/µs to 1kV/µs range usually caused by lightning disturbances.

The SL1011A/B and SL1411A series offers low capacitance (< 1.5pf) which provides low insertion loss at high frequencies.

SL1011A offers 5kA protection without destruction whereas the SL1011B and SL1411A offer 10kA surge protection without destruction (maximum single surge of 12kA @ 8/20µs).

Features

- RoHS compliant
- Low insertion loss
- Excellent response to fast rising transients
- Ultra low capacitance
- 5kA (SL1011A) or 10kA (SL1011B & SL1411A) surge capability tested with 8/20µs pulse as defined by IEC 61000-4-5

Applications

- Broadband equipment
- ADSL equipment
- XDSL equipment
- Satellite and CATV equipment
- General telecom equipment

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Electrical Characteristics

	Device Specifications (at 25°C)					Life Ratings									
Part Number	ir	Breako n Volts @100V/		Impulse Breakdown in Volts ³ (@100V/µs)	Impulse Breakdown In Volts (@1kV/µs)		Capaci- tance (@1MHz)	Arc Voltage (on state Voltage) @1Amp Min	Surge Life (@100A 10/1000µs)	Nominal Impulse Discharge Current (8/20µs)	Nominal AC Discharge Current (10x1s @50-60Hz)	AC Dischage Current (9 Cycles @ 50Hz)	DC Holdover Voltage ⁴	Discharg	mpulse e Current lication)
	MIN	TYP	MAX	MAX		MIN	MAX	TYP					TYP	@ 8/20μs	@ 10/350µs
SL1011A075															
SL1011B075	60	75	90	500	700										
SL1411A075						10 ¹⁰ Ω (at 50V)							50 V		
SL1011A090				500	600										
SL1011B090	72	90	108												
SL1411A090															
SL1011A145	116	145	174	500	650										
SL1011B145															
SL1011A150 SL1011B150	120	150	180	500	650										
SL1011B150						-				SL1011A:					
SL1011B230	184	230	276	550	700					10 shots	SL1011A:	SL1011A:			
SL1411A230	104	230 21	210		700	1.5 10 ¹⁰ Ω (at 100V)	1.5 pF	1.5 pF ~20 V	300 shots	(@5kA)	5 A SL1011B & SL1411A: 10 A	20 A SL1011B & SL1411A: 65 A	135 V	SL1011B & SL1411A: 12 kA	1 kA
SL1011A250										SL1011B & SL1411A: 10 shots (@10kA)					
SL1011B250	200	250 3	300	600	800										
SL1411A250															
SL1011A260				600	800										
SL1011B260	210	260 310	310												
SL1011A350															
SL1011B350	280	350	420	800	900										
SL1411A350															
SL1011A470	276	276 470	564	1000	1100										
SL1411A470	376 470	470	304												
SL1011A500	400	500	600	1100	1200										
SL1011A600	480	600	720	1200	1400										
SL1411A600	+00	300	120	1200	1700										

Notes

- 1. At delivery AQL 0.65 level II, DIN ISO 2859
- 2. In ionized mode
- 3. Comparable to the silicon measurement Switching Voltage (Vs)
- 4. Tested according to ITU-T Rec. K.12 < 150 msecs.

Product Characteristics

Materials	Leaded Device: Nickel-plated with Tin- plated wires Core and Surface Mount: Dull Tin-plated	
Product Marking	Littelfuse 'LF' Mark, voltage and date code	

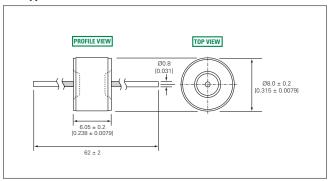
Glow to Arc Transition Current	< 0.5 Amps	
Glow Voltage	~60 Volts	
Storage and Operational Temperature	-40 to +90°C	



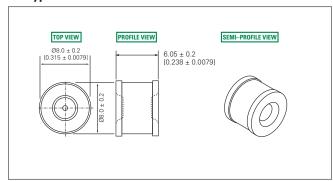
Device Dimensions

For SL1011A/SL1011B series:

'A' Type Axial Lead Devices

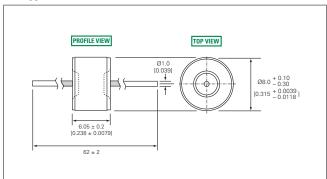


'C' Type Core Devices

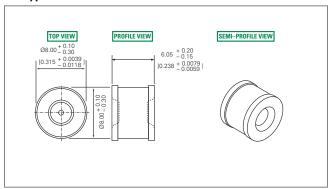


For SL1411A series:

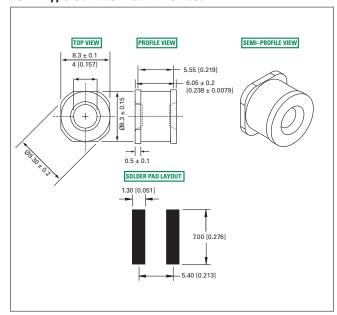
'A' Type Axial Lead Devices



'C' Type Core Devices



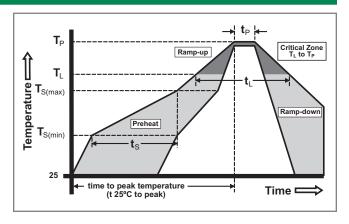
'SM' Type Surface Mount Devices



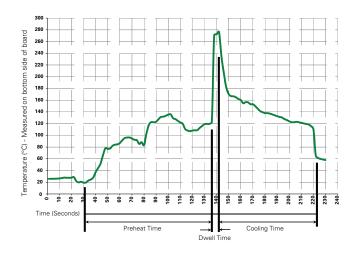


Soldering Parameters - Reflow Soldering (Surface Mount Devices)

Reflow Co	ndition	Pb-free assembly		
	-Temperature Min (T _{s(min)})	150°C		
Pre Heat	-Temperature Max (T _{s(max)})	200°C		
	-Time (Min to Max) (t _s)	60 – 180 seconds		
Average R (T _L) to pea	amp-up Rate (Liquidus Temp k)	3°C/second max.		
T _{S(max)} to T _L	- Ramp-up Rate	5°C/second max.		
Reflow	-Temperature (T _L) (Liquidus)	217°C		
nellow	-Temperature (t _L)	60 – 150 seconds		
PeakTemp	erature (T _P)	260 ^{+0/-5} °C		
Time with Temperatu	in 5°C of Actual Peak ure (t _p)	10 – 30 seconds		
Ramp-dov	vn Rate	6°C/second max.		
Time 25°C	to Peak Temperature (T _P)	8 minutes max.		
Do not exc	ceed	260°C		



Soldering Parameters - Wave Soldering (Thru-Hole Devices)



Recommended Process Parameters:

Wave Parameter	Lead-Free Recommendation		
Preheat:			
(Depends on Flux Activation Temperature)	(Typical Industry Recommendation)		
Temperature Minimum:	100° C		
Temperature Maximum:	150° C		
Preheat Time:	60-180 seconds		
Solder Pot Temperature:	280° C Maximum		
Solder DwellTime:	2-5 seconds		

Soldering Parameters - Hand Soldering

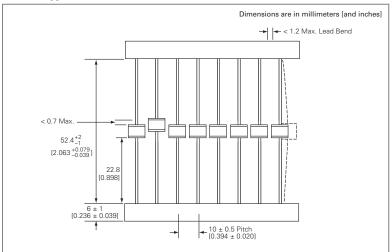
Solder Iron Temperature: 350° C +/- 5°C

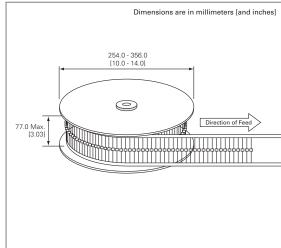
Heating Time: 5 seconds max.

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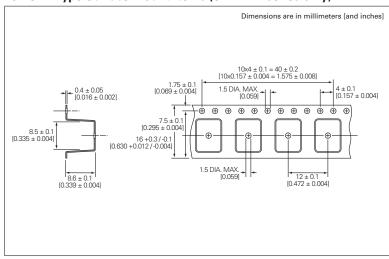
Packaging Dimensions

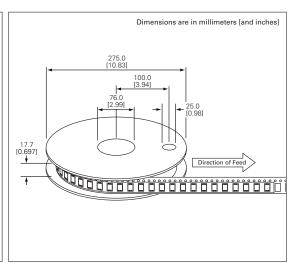
For 'A' Type Axial Lead Items





For 'SM' Type Surface Mount Items (SL1411A series only)





For 'C' Type Core Items: Packed in plastic bag (500 pcs)

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Part Numbering System and Ordering Information

For SL1011A series:

SL1011A XXX X Voltage — Pin Configuration -A = Axial Lead

C = Core

Remarks: Formed leads are available on request

For SL1011B series:

SL1011B XXX X Voltage -Pin Configuration -

A = Axial Lead

C = Core

Remarks: Formed leads are available on request

For SL1411A series:

SL1411 A XXX XX Surge Capability — Voltage — Pin Configuration -

A = Axial Lead

C = Core

SM = Surface Mount